EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	masashi near3 gotoh.in. and plating with via	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 13:29
L2	1	kaoru near3 kawasaki.in. and (plated plating) with via not 1	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 13:33
L3	12	hiroshi near3 yamamoto.in. and (plated plating) with via not 1 not 2	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 13:34
L4	2	mutsuko near3 nakano.in. and (plated plating) with vianot 1 not 2 not 3	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 13:36
L5	0	mutsuko near3 nakano.in. and (plated plating) with via not 1 not 2 not 3	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 13:36
L6	2	((multi\$1layer multi\$1 part ((plurality multiple) with (layer part section))) with (via hole aperture open \$3) with (((electrode electrolytic electric chemical\$2) with plat\$3) electroplat \$3) and (then after follow\$3 next) with electroless near4 plat\$3 with (via hole aperture open \$3) and (prepreg insulat\$3 dielectric	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 14:03

		silicon si) near3 (layer film sheet substrate board) with (via hole aperture open\$3)). clm.			***************************************	
L7	88	((via hole aperture open\$3) with (fill \$3 plug\$4) and (via hole aperture open\$3) with (((electrode electrolytic electric chemical\$2) near3 plat\$3) electroplat \$3) and (via hole aperture open\$3) with electroless near3 plat\$3 and (prepreg insulat\$3 dielectric silicon si) near3 (layer film sheet substrate board) with (via hole aperture open \$3)).clm.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 14:06
L8	**************************************	((via hole aperture open\$3) with (fill \$3 plug\$4) and (via hole aperture open\$3) with (((electrode electrolytic electric chemical\$2) near3 plat\$3) electroplat \$3) same (via hole aperture open\$3) with electroless near3 plat\$3 and (prepreg insulat\$3 dielectric silicon si) near3 (layer film sheet substrate board) with (via hole aperture open\$3)) and (via hole aperture open\$3) with laser	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 14:27

L9	136	8 and "29"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 14:28
L10	150	8 and "361"/\$ not 9	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 14:34
L11	119	8 and "174"/\$ not 9 not 10	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 17:10
L12	164	8 and "438"/\$ not 9 not 10 not 11	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 17:21
L13	117	8 and "257"/\$ not 9 not 10 not 11 not 12	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/02/06 17:36
S113	1	"6708405".pn.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2009/01/29 12:34
S114	13	("5502006" "5622883" "5668041" "5821141" "5879985" "5952687" "6107136" "6165833" "6309977").PN. OR ("6708405"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/01/29 12:40
S115	41	("5696395" "5861647" "5892282" "5907772" "5909621" "5968851" "5972722" "5973351" "5981331" "5981377").PN. OR ("6107136"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/01/29 12:43

2/6/09 5:43:08 PM

C:\ Documents and Settings\ dnguyen21\ My Documents\ EAST\ Workspaces \ 10549571 Via platg.wsp